

# NBSG111

## 2.5V/3.3V SiGe Differential 1:10 Clock/Data Driver with RSECL\* Outputs

### \*Reduced Swing ECL

#### Description

The NBSG111 is a 1-to-10 differential clock/data driver. The device is functionally equivalent to the LVEP111 device with much higher bandwidth and lower EMI capabilities.

Inputs incorporate internal 50  $\Omega$  termination resistors (input to VT pad) and accept NECL (Negative ECL), PECL (Positive ECL), LVTTTL, LVCMOS, CML, or LVDS. Outputs are RSECL (Reduced Swing ECL), 400 mV.

The  $Q[0:9] / \overline{Q}[0:9]$  outputs have a differential synchronous enable ( $EN/\overline{EN}$ ) pin. The synchronous enable pin is used to avoid a runt clock pulse when the device is enabled/disabled as can happen with an asynchronous control. The internal flip flop is clocked on the falling edge of selected clock ( $CLK0/\overline{CLK0}$  or  $CLK1/\overline{CLK1}$ ), therefore all associated specification limits are referenced to the negative edge of the selected clock input.

The  $V_{BB}$  and  $V_{MM}$  pins are internally generated voltage supplies available to this device only. The  $V_{BB}$  is used for single-ended NECL or PECL inputs and the  $V_{MM}$  pin is used for LVCMOS inputs. For single-ended input operation, the unused differential input is connected to  $V_{BB}$  or  $V_{MM}$  as a switching reference voltage.  $V_{BB}$  or  $V_{MM}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{MM}$  via a 0.01  $\mu$ F capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  and  $V_{MM}$  outputs should be left open.

#### Features

- Maximum Input Clock Frequency > 6 GHz Typical
- Maximum Input Data Rate > 6 Gb/s Typical
- 300 ps Typical Propagation Delay
- 60 ps Typical Rise and Fall Times
- RSPECL Output with Operating Range:  $V_{CC} = 2.375$  V to 3.465 V with  $V_{EE} = 0$  V
- RSNECL Output with RSNECL or NECL Inputs with Operating Range:  $V_{CC} = 0$  V with  $V_{EE} = -2.375$  V to  $-3.465$  V
- RSECL Output Level (400 mV Peak-to-Peak Output), Differential Output
- 50  $\Omega$  Internal Input Termination Resistors
- Compatible with Existing 2.5 V/3.3 V LVEP and EP Devices
- $V_{BB}$  and  $V_{MM}$  Reference Voltage Output
- Pb-Free Package is Available\*

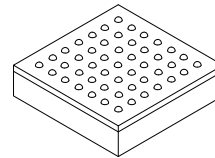
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



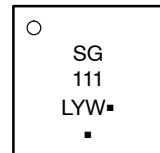
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#### MARKING DIAGRAM\*



FCBGA-49  
BA SUFFIX  
CASE 489A



SG111 = Device Code  
L = Wafer Lot  
Y = Year  
W = Work Week  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*For further details, refer to Application Note AND8002/D

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

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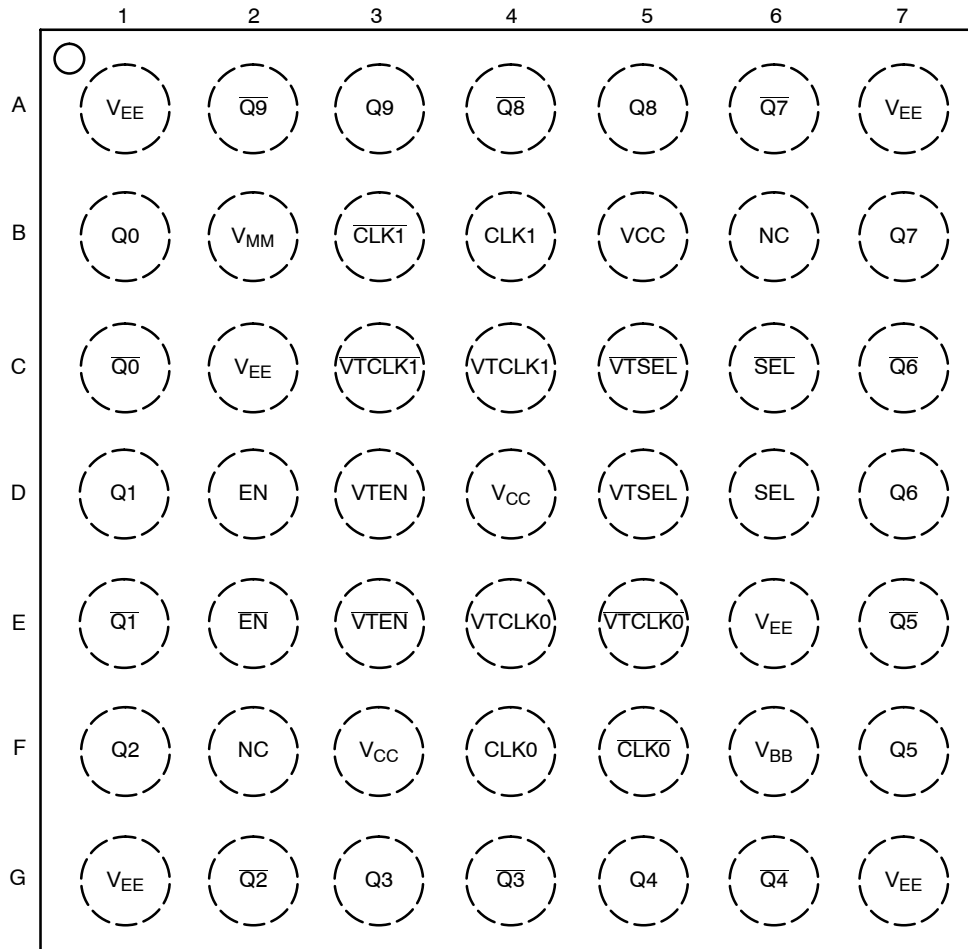


Figure 1. BGA-49 Pinout (Top View)

Table 1. PIN DESCRIPTION

Pin	Name	I/O	Description
A1,A7,G1,G7,C2,E6	$V_{EE}$	-	Negative Supply Voltage. All $V_{EE}$ Pins Must be Externally Connected to Power Supply to Guarantee Proper Operation.
F3,D4,B5	$V_{CC}$	-	Positive Supply Voltage. All $V_{CC}$ Pins Must be Externally Connected to Power Supply to Guarantee Proper Operation.
B2	$V_{MM}$	-	LVC MOS Reference Voltage Output $(V_{CC} - V_{EE}) / 2$ .
F6	$V_{BB}$	-	ECL Reference Voltage Output
E4	VTCLK0	-	Internal 50 $\Omega$ Termination Pin for CLK0. See Table 4. (Note 1)
F4	CLK0	ECL, CML, LVCMOS, LVDS, LVTTTL Input	Noninverted Differential Input CLK0. Internal 75 k $\Omega$ to $V_{EE}$ .
E5	$\overline{VTCLK0}$	-	Internal 50 $\Omega$ Termination Pin for $\overline{CLK0}$ . See Table 4. (Note 1)
F5	$\overline{CLK0}$	ECL, CML, LVCMOS, LVDS, LVTTTL Input	Inverted Differential Input $\overline{CLK0}$ . Internal 75 k $\Omega$ to $V_{EE}$ and 36.5 k $\Omega$ to $V_{CC}$ .
C4	VTCLK1	-	Internal 50 $\Omega$ Termination Pin 1. See Table 4. (Note 1)
B4	CLK1	ECL, CML, LVCMOS, LVDS, LVTTTL Input	Noninverted Differential Input CLK1. Internal 75 k $\Omega$ to $V_{EE}$ .
C3	$\overline{VTCLK1}$	-	Internal 50 $\Omega$ Termination Pin for $\overline{CLK1}$ . See Table 4. (Note 1)
B3	$\overline{CLK1}$	ECL, CML, LVCMOS, LVDS, LVTTTL Input	Inverted Differential Input $\overline{CLK1}$ . Internal 75 k $\Omega$ to $V_{EE}$ and 36.5 k $\Omega$ to $V_{CC}$ .
B1,D1,F1,G3,G5,F7,D7,B7,A5,A3	Q[0:9]	RSECL Output	Noninverted Differential Outputs [0:9]. Typically Terminated with 50 $\Omega$ to $V_{TT} = V_{CC} - 1.5 V$
C1,E1,G2,G4,G6,E7,C7,A6,A4,A2	$\overline{Q}$ [0:9]	RSECL Output	Inverted Differential Outputs [0:9]. Typically Terminated with 50 $\Omega$ to $V_{TT} = V_{CC} - 1.5 V$
D5	VTSEL	-	Internal 50 $\Omega$ Termination Pin for SEL. See Table 4. (Note 1)
D6	SEL	ECL, CML, LVCMOS, LVDS, LVTTTL Input	Noninverted Differential Select Logic Input. Internal 75 k $\Omega$ to $V_{EE}$ .
C5	$\overline{VTSEL}$	-	Internal 50 $\Omega$ Termination Pin for SEL. See Table 4. (Note 1)
C6	$\overline{SEL}$	ECL, CML, LVCMOS, LVDS, LVTTTL Input	Inverted Differential Select Logic Input. Internal 75 k $\Omega$ to $V_{EE}$ and 36.5 k $\Omega$ to $V_{CC}$ .
D3	VTEN	-	Internal 50 $\Omega$ Termination Pin for EN. See Table 4. (Note 1)
D2	EN	ECL, CML, LVCMOS, LVDS, LVTTTL Input	Noninverted Differential Output Enable Pin. Internal 75 k $\Omega$ to $V_{EE}$ .
E3	$\overline{VTEN}$	-	Internal 50 $\Omega$ termination Pin for $\overline{EN}$ . See Table 4. (Note 1)
E2	$\overline{EN}$	ECL, CML, LVCMOS, LVDS, LVTTTL Input	Inverted Differential Output Enable Pin. Internal 75 k $\Omega$ to $V_{EE}$ and 36.5 k $\Omega$ to $V_{CC}$ .
F2,B6	NC	-	No Connect. The NC Pins are Electrically Connected to the Die and "MUST BE" Left Open.

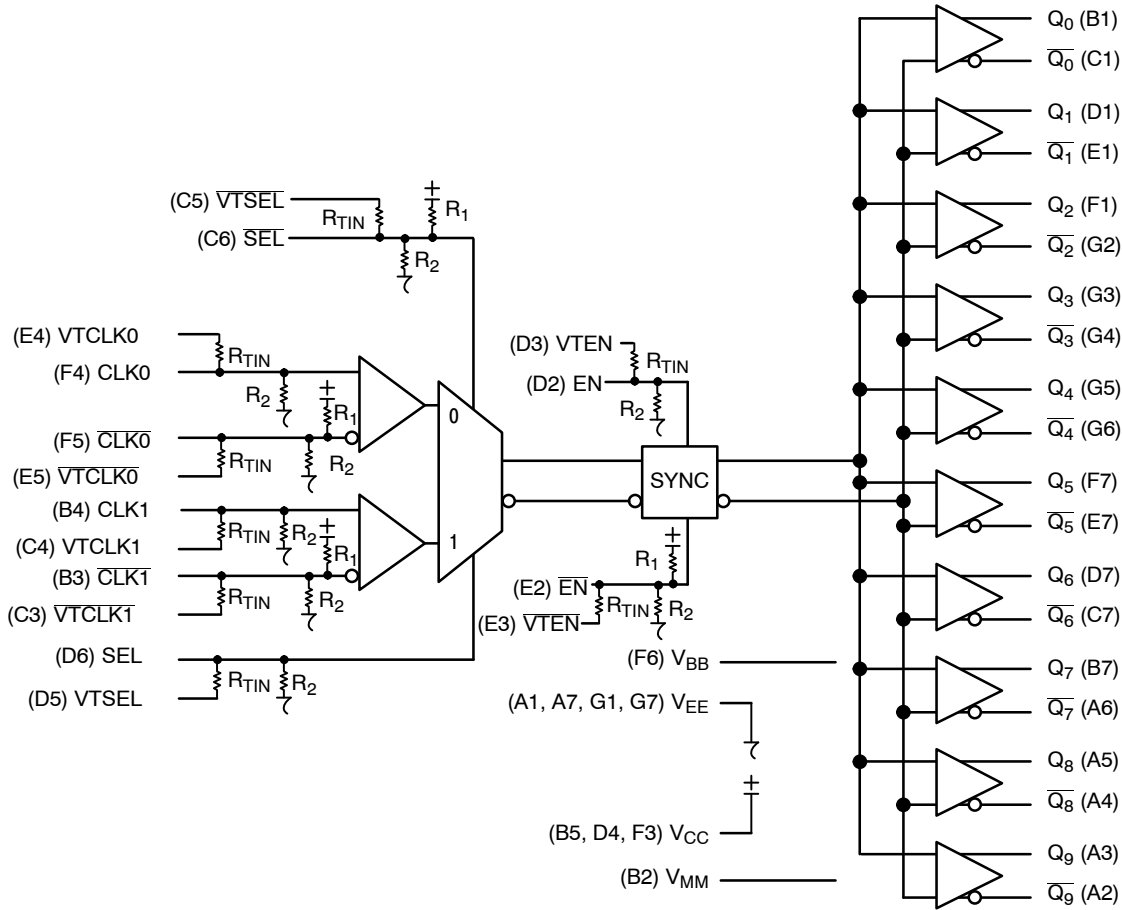
1. In the differential configuration when the input termination pins (VTCLK,  $\overline{VTCLK}$ ) are connected to a common termination voltage and if no signal is applied, then the device will be susceptible to self-oscillation.

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**Table 2. FUNCTION TABLE**

SEL	EN	Active Input
L	L	Disabled Outputs
L	H	CLK0, $\overline{\text{CLK0}}$
H	L	Disabled Outputs
H	H	CLK1, $\overline{\text{CLK1}}$

2.  $\overline{\text{SEL}}/\overline{\text{EN}}$  are the inverse of SEL/EN unless specified otherwise.



**Figure 2. Logic Diagram**

**Table 3. INTERFACING OPTIONS**

INTERFACING OPTIONS	CONNECTIONS
CML	Connect VTCLK0, VTCLK1, VTEN, VTSEL and $\overline{\text{VTCLK0}}$ , $\overline{\text{VTCLK1}}$ , $\overline{\text{VTEN}}$ , $\overline{\text{VTSEL}}$ to $V_{CC}$
LVDS	Connect VTCLK0, VTCLK1, VTEN, VTSEL and $\overline{\text{VTCLK0}}$ , $\overline{\text{VTCLK1}}$ , $\overline{\text{VTEN}}$ , $\overline{\text{VTSEL}}$ Together
AC-COUPLED	Bias VTCLK0, VTCLK1, VTEN, VTSEL and $\overline{\text{VTCLK0}}$ , $\overline{\text{VTCLK1}}$ , $\overline{\text{VTEN}}$ , $\overline{\text{VTSEL}}$ Inputs within Common Mode Range ( $V_{IHCMR}$ )
RSECL, PECL, NECL	Standard ECL Termination Techniques
LVTTL, LVCMOS	See Text on Page 1. Unused Differential Input Switching Voltage Reference Range is from $V_{EE} + 1125 \text{ mV}$ to $V_{CC} - 75 \text{ mV}$

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**Table 4. ATTRIBUTES**

Characteristics	Value
Internal Input Pulldown Resistor, R2 (CLK0, $\overline{\text{CLK0}}$ , CLK1, $\overline{\text{CLK1}}$ , SEL, $\overline{\text{SEL}}$ , EN, $\overline{\text{EN}}$ )	75 k $\Omega$
Internal Input Pullup Resistor, R1 ( $\overline{\text{CLK0}}$ , $\overline{\text{CLK1}}$ , $\overline{\text{SEL}}$ , $\overline{\text{EN}}$ )	36.5 k $\Omega$
ESD Protection	Human Body Model Machine Model Charged Device Model
	> 2 kV > 100 V > 1 kV
Moisture Sensitivity (Note 3)	Level 3
Flammability Rating	Oxygen Index: 28 to 34
	UL 94 V-0 @ 0.125 in
Transistor Count	479
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

3. For additional information, see Application Note AND8003/D.

**Table 5. MAXIMUM RATINGS**

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V <sub>CC</sub>	Positive Power Supply	V <sub>EE</sub> = 0 V		3.6	V
V <sub>I</sub>	Positive Input Negative Input	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	V <sub>I</sub> ≤ V <sub>CC</sub> V <sub>I</sub> ≥ V <sub>EE</sub>	3.6 -3.6	V V
V <sub>EE</sub>	Negative Power Supply	V <sub>CC</sub> = 0 V		-3.6	V
V <sub>INPP</sub>	Differential Input Voltage  CLK - $\overline{\text{CLK}}$	V <sub>CC</sub> - V <sub>EE</sub> ≥ 2.8 V V <sub>CC</sub> - V <sub>EE</sub> < 2.8 V		2.8  V <sub>CC</sub> - V <sub>EE</sub>	V V
I <sub>OUT</sub>	Output Current	Continuous Surge		25 50	mA mA
I <sub>IN</sub>	Input Current Through R <sub>T</sub> (50 $\Omega$ Resistor)	Static Surge		45 80	mA mA
I <sub>BB</sub>	V <sub>BB</sub> Sink/Source			1	mA
I <sub>MM</sub>	V <sub>MM</sub> Sink/Source			1	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +70	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient) (Note 4)	0 LFPM 500 LFPM	49 FCBGA 49 FCBGA	67 57	°C/W °C/W
$\theta_{JC}$	Thermal Resistance (Junction-to-Case)	2S2P (Note 4)	49 FCBGA	2 to 4	°C/W
T <sub>sol</sub>	Wave Solder	< 15 sec.		225	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

4. JEDEC standard 51-6, multilayer board – 2S2P (2 signal, 2 power).

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**Table 6. DC CHARACTERISTICS, INPUT WITH RSPECL OUTPUT**  $V_{CC} = 2.5\text{ V}$ ;  $V_{EE} = 0\text{ V}$  (Note 5)

Symbol	Characteristic	-40°C			25°C			70°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Negative Power Supply Current	70	85	110	70	85	110	70	85	110	mA
$V_{OH}$	Output HIGH Voltage (Note 6)	1365	1520	1615	1410	1530	1660	1435	1560	1685	mV
$V_{OUTPP}$	Output Voltage Amplitude	305	420	545	305	420	545	305	420	545	mV
$V_{IH}$	Input HIGH Voltage (Single-Ended) (Notes 8 and 9)	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	mV
$V_{IL}$	Input LOW Voltage (Single-Ended) (Notes 8 and 10)	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	mV
$V_{BB}$	PECL Output Voltage Reference	1025	1100	1265	1025	1100	1265	1025	1100	1265	mV
$V_{IHCMR}$	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 7)	1.2		2.5	1.2		2.5	1.2		2.5	V
$V_{MM}$	LVC MOS Output Voltage Reference (@ 2.5 $V_{CC}$ )	1050	1250	1450	1050	1250	1450	1050	1250	1450	mV
$R_{TIN}$	Internal Input Termination Resistor	45	50	55	45	50	55	45	50	55	$\Omega$
$I_{IH}$	Input HIGH Current (@ $V_{IH}$ )		30	100		30	100		30	100	$\mu\text{A}$
$I_{IL}$	Input LOW Current (@ $V_{IL}$ )		25	100		25	100		25	100	$\mu\text{A}$

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

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**Table 7. DC CHARACTERISTICS, INPUT WITH RSPECL OUTPUT**  $V_{CC} = 3.3\text{ V}$ ;  $V_{EE} = 0\text{ V}$  (Note 11)

Symbol	Characteristic	-40°C			25°C			70°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Negative Power Supply Current	70	85	110	70	85	110	70	85	110	mA
$V_{OH}$	Output HIGH Voltage (Note 6)	2165	2320	2415	2210	2330	2460	2235	2360	2485	mV
$V_{OUTPP}$	Output Voltage Amplitude	305	420	545	305	420	545	305	420	545	mV
$V_{IH}$	Input HIGH Voltage (Single-Ended) (Notes 8 and 9)	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	mV
$V_{IL}$	Input LOW Voltage (Single-Ended) (Notes 8 and 10)	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	mV
$V_{BB}$	PECL Output Voltage Reference	1825	1900	2065	1825	1900	2065	1825	1900	2065	mV
$V_{IHCMR}$	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 7)	1.2		3.3	1.2		3.3	1.2		3.3	V
$V_{MM}$	LVC MOS Output Voltage Reference (@ 3.3 $V_{CC}$ )	1450	1650	1850	1450	1650	1850	1450	1650	1850	mV
$R_{TIN}$	Internal Input Termination Resistor	45	50	55	45	50	55	45	50	55	$\Omega$
$I_{IH}$	Input HIGH Current (@ $V_{IH}$ )		30	100		30	100		30	100	$\mu\text{A}$
$I_{IL}$	Input LOW Current (@ $V_{IL}$ )		25	100		25	100		25	100	$\mu\text{A}$

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.125 V to -0.965 V.  $V_{MM}$  varies  $(V_{CC} - V_{EE}) / 2$  with  $V_{CC}$  and  $V_{EE}$ .
  6. All outputs loaded with 50  $\Omega$  to  $V_{CC} - 1.5\text{ V}$ .  $V_{OH}/V_{OL}$  measured at  $V_{IH}/V_{IL}$  (Typical).
  7.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ ,  $V_{IHCMR}$  max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential input signal.
  8.  $V_{THR}$  is the voltage applied to the complementary input, typically  $V_{BB}$  or  $V_{MM}$ .  $V_{THR(MIN)} = V_{IHCMR} + 75\text{ mV}$ .  $V_{THR(MAX)} = V_{IHCMR} - 75\text{ mV}$ .
  9.  $V_{IH}$  cannot exceed  $V_{CC}$ .
  10.  $V_{IL}$  always  $\geq V_{EE}$ .
  11. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.925 V to -0.165 V.  $V_{MM}$  varies  $(V_{CC} - V_{EE}) / 2$  with  $V_{CC}$  and  $V_{EE}$ .
- \*Typicals used for testing purposes.

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**Table 8. DC CHARACTERISTICS, NECL OR RSNECL INPUT WITH NECL OUTPUT**

$V_{CC} = 0\text{ V}$ ;  $V_{EE} = -3.465\text{ V}$  to  $-2.375\text{ V}$  (Note 12)

Symbol	Characteristic	-40°C			25°C			70°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Negative Power Supply Current	70	85	110	70	85	110	70	85	110	mA
$V_{OH}$	Output HIGH Voltage (Note 13)	-1135	-980	-885	-1090	-970	-840	-1065	-940	-815	mV
$V_{OUTPP}$	Output Voltage Amplitude	305	420	545	305	420	545	305	420	545	mV
$V_{IH}$	Input HIGH Voltage (Single-Ended) (Notes 15 and 16)	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	$V_{THR} + 75$	$V_{CC} - 1000^*$	$V_{CC}$	mV
$V_{IL}$	Input LOW Voltage (Single-Ended) (Notes 15 and 17)	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	$V_{IH} - 2500$	$V_{CC} - 1400^*$	$V_{THR} - 75$	mV
$V_{BB}$	NECL Output Voltage Reference	-1475	-1400	-1235	-1475	-1400	-1235	-1475	-1400	-1235	mV
$V_{IHCMR}$	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 14)	$V_{EE}+1.2$		0.0	$V_{EE}+1.2$		0.0	$V_{EE}+1.2$		0.0	V
$V_{MM}$	LVC MOS Output Voltage Reference (@ -2.5 $V_{EE}$ ) (@ -3.3 $V_{EE}$ )	-1450 -1850	-1250 -1650	-1050 -1450	-1450 -1850	-1250 -1650	-1050 -1450	-1450 -1850	-1250 -1650	-1050 -1450	mV
$R_{TIN}$	Internal Input Termination Resistor	45	50	55	45	50	55	45	50	55	$\Omega$
$I_{IH}$	Input HIGH Current (@ $V_{IH}$ )		30	100		30	100		30	100	$\mu\text{A}$
$I_{IL}$	Input LOW Current (@ $V_{IL}$ )		25	100		25	100		25	100	$\mu\text{A}$

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

12. Input and output parameters vary 1:1 with  $V_{CC}$ .

13. All outputs loaded with 50  $\Omega$  to  $V_{CC} - 1.5\text{ V}$ .  $V_{OH}/V_{OL}$  measured at  $V_{IH}/V_{IL}$  (Typical).

14.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ .  $V_{IHCMR}$  max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential input signal.

15.  $V_{THR}$  is the voltage applied to the complementary input, typically  $V_{BB}$  or  $V_{MM}$ .  $V_{THR(MIN)} = V_{IHCMR} + 75\text{ mV}$ .  $V_{THR(MAX)} = V_{IHCMR} - 75\text{ mV}$ .

16.  $V_{IH}$  cannot exceed  $V_{CC}$ .

17.  $V_{IL}$  always  $\geq V_{EE}$ .

\*Typicals used for testing purposes.



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**Table 9. AC CHARACTERISTICS**  $V_{CC} = 0\text{ V}$ ;  $V_{EE} = -3.465\text{ V}$  to  $-2.375\text{ V}$  or  $V_{CC} = 2.375\text{ V}$  to  $3.465\text{ V}$ ;  $V_{EE} = 0\text{ V}$

Symbol	Characteristic	-40°C			25°C			70°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$V_{OUTPP}$	Output Voltage Amplitude (See Figure 3) (Note 18) $f_{in} < 3\text{ GHz}$ $f_{in} = 5.5\text{ GHz}$	305 180	420 250		305 150	420 220		305 100	420 200		mV
$t_{PLH}$ , $t_{PHL}$	Propagation Delay to Output Differential Output Enable Clock Select	250 430 400	300 550 450	350 700 500	250 430 400	300 550 450	350 700 500	250 430 400	300 600 480	350 750 550	ps
$t_{SKEW}$	Duty Cycle Skew (Note 19) Within-Device Skew (Note 20) Device-to-Device Skew (Note 21)		2 5 15	15 20 85		2 5 15	15 20 85		2 5 15	15 20 85	ps
$t_S$	Setup Time to CLK (EN to Selected CLK0:1)	110	70		110	70		115	80		ps
$t_H$	Hold Time (EN to Selected CLK0:1)	110	70		110	70		115	80		ps
$t_{JITTER}$	RMS Random Clock Jitter (Figure 3) (Note 23) Peak-to-Peak Data Dependent Jitter (Note 24) $f_{in} = 5\text{ GHz}$ $f_{in} = 5\text{ Gb/s}$		0.5	2.0		0.5 14	2.0		0.5	2.0	ps
$V_{INPP}$	Input Voltage Swing/Sensitivity (Differential Configuration) (Note 22)	75		2600	75		2600	75		2600	mV
$t_r$ $t_f$	Output Rise/Fall Times (20% – 80%) @ 1 GHz Q, $\bar{Q}$	40	60	80	40	60	80	40	60	80	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

18. Measured using a 500 mV source, 50% duty cycle clock source. All outputs loaded with  $50\ \Omega$  to  $V_{CC} - 1.5\text{ V}$ . Input edge rates 40 ps (20% – 80%).

19.  $t_{SKEW} = |t_{PLH} - t_{PHL}|$  for a nominal 50% differential clock input waveform (Figure 4).

20. Within-Device skew is measured between outputs under identical transitions and conditions on any one device.

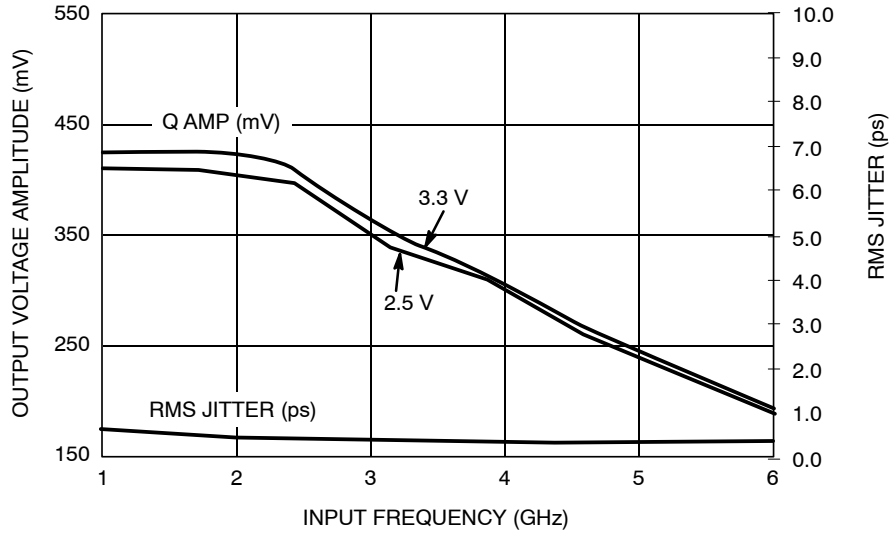
21. Device-to-Device skew for identical transitions at identical  $V_{CC}$  levels.

22.  $V_{INPP}$  (MAX) cannot exceed  $V_{CC} - V_{EE}$  (applicable only when  $V_{CC} - V_{EE} < 2600\text{ mV}$ ).

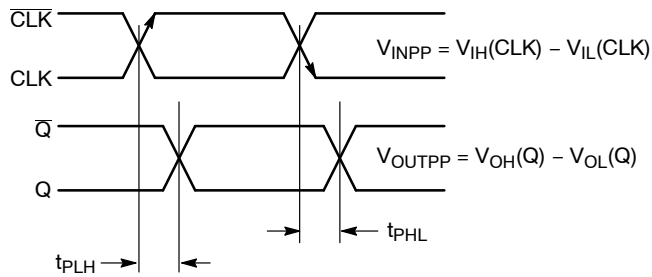
23. Additive RMS jitter with 50% duty cycle clock signal at 5 GHz.

24. Additive Peak-to-Peak jitter with input NRZ data at PRBS  $2^{31}-1$  at 5 Gb/s.

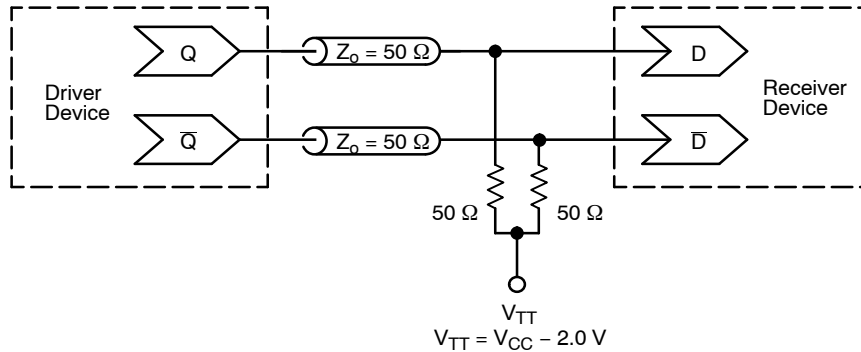
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**Figure 3. Output Voltage Amplitude ( $V_{OUTPP}$ ) / RMS Jitter vs. Input Frequency ( $f_{in}$ ) at Ambient Temperature (Typical)**



**Figure 4. AC Reference Measurement**



**Figure 5. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)**

## ORDERING INFORMATION

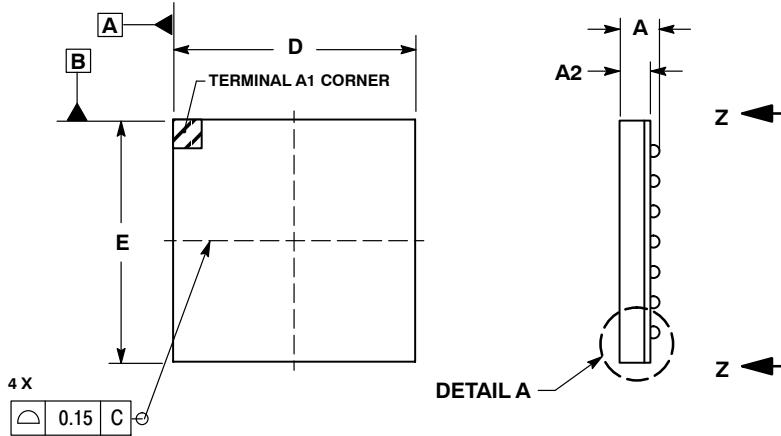
Device	Package	Shipping <sup>†</sup>
NBSG111BAHTBG	FCBGA-49 (Pb-Free)	100 / Tape & Reel
NBSG111BA	FCBGA-49	100 Units / Tray (Contact Sales Representative)
NBSG111BAR2	FCBGA-49	500 / Tape & Reel (Contact Sales Representative)

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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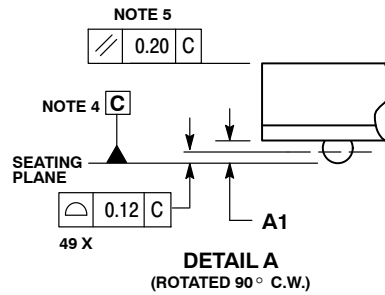
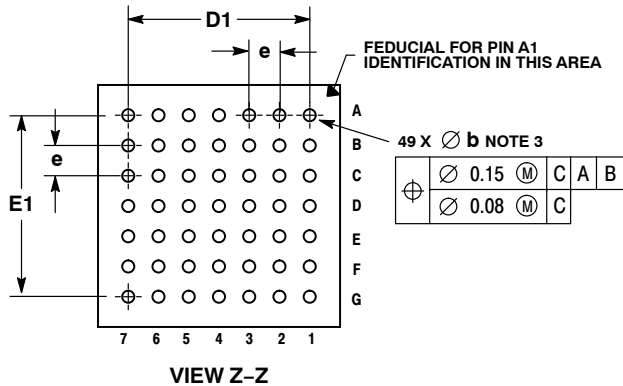
## PACKAGE DIMENSIONS

**FCBGA-49  
BA SUFFIX**  
PLASTIC 8x8 mm (1.0 mm pitch) BGA FLIP CHIP PACKAGE  
CASE 489A-02  
ISSUE A



- NOTES:
1. CONTROLLING DIMENSION: MILLIMETER.
  2. DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
  3. DIMENSION b IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO DATUM PLANE C.
  4. DATUM C (SEATING PLANE) IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
  5. PARALLELISM MEASUREMENT SHALL EXCLUDE ANY EFFECT OF MARK ON TOP SURFACE OF PACKAGE.
  6. 489A-01 OBSOLETE, NEW STANDARD 489A-02.

DIM	MILLIMETERS	
	MIN	MAX
A	---	1.40
A1	0.3	0.5
A2	0.91	REF
b	0.40	0.60
D	8.00	BSC
D1	6.00	BSC
E	8.00	BSC
E1	6.00	BSC
e	1.00	BSC



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